Components marked 'DNP' should not be populated.
Assembly Variant: 001

PCB VIEWED FROM TOP SIDE  BOARD #: ISE4002  REV: E1  SVN REV: Not In VersionControl
IGNORE -> Top Overlay

PLOT NAME = Top Assembly Drawing  GENERATED : 3/12/2014  9:58:26 AM  TEXAS INSTRUMENTS
COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
ASSEMBLY VARIANT: 001

<table>
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<th>PCB VIEWED FROM BOTTOM SIDE</th>
<th>BOARD #: ISE4002</th>
<th>REV: E1</th>
<th>SVN REV: Not In VersionControl</th>
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<td></td>
<td>IGNORE</td>
<td>Bottom Overview</td>
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<tr>
<td>PLOT NAME = Bottom Assembly Drawing</td>
<td>GENERATED: 3/12/2014 9:58:26 AM</td>
<td>TEXAS INSTRUMENTS</td>
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